2SD2323

Silicon NPN Triple Diffused

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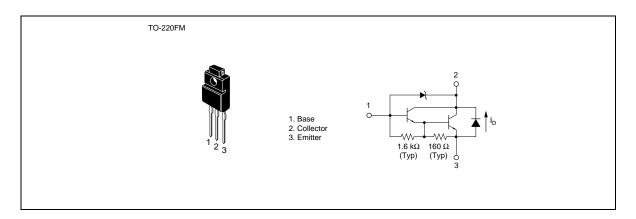
Application

High voltage switching, igniter

Features

- Built-in High voltage zener diode (300 V)
- High speed switching

Outline



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Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

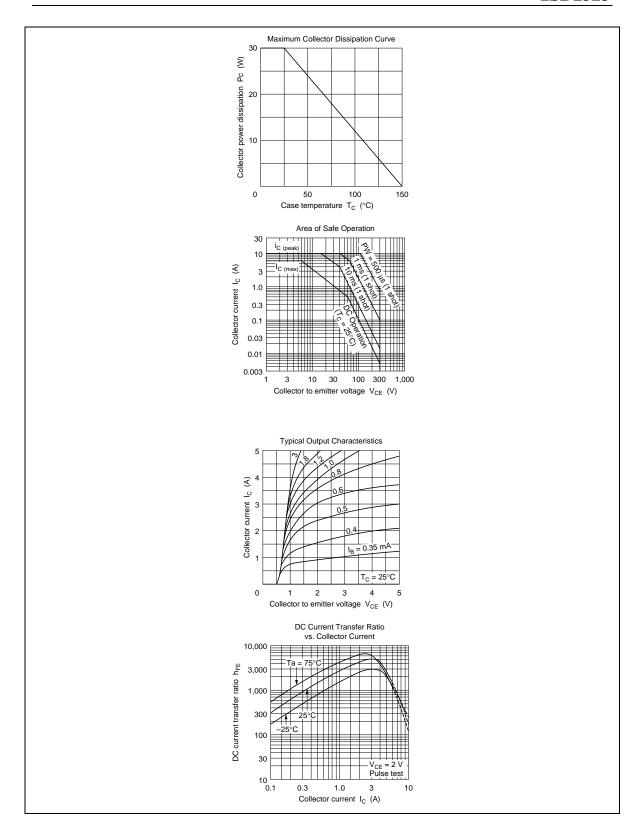
Symbol	Rating	Unit
V _{CBO}	300	V
V _{CEO}	300	V
$V_{\scriptscriptstyle{EBO}}$	7	V
I _c	6	A
I _D *1	6	A
I _{C(peak)}	10	A
P _c *1	30	W
Tj	150	°C
Tstg	-55 to +150	°C
	V_{CBO} V_{CEO} V_{EBO} I_{C} I_{D}^{*1} $I_{C(peak)}$ P_{C}^{*1} Tj	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

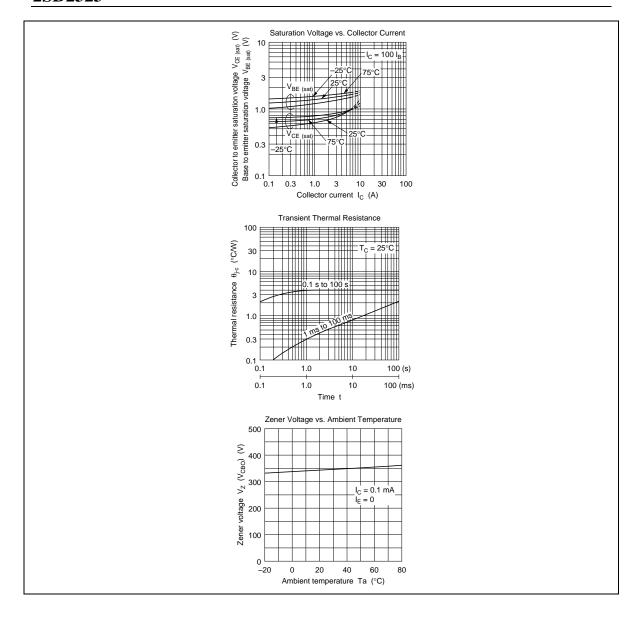
Note: 1. Value at $T_c = 25$ °C.

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\text{(BR)CBO}}$	300	_	420	V	$I_{c} = 0.1 \text{ mA}, I_{E} = 0$
Collector to emitter sustain voltage	$V_{\text{CEO(SUS)}}$	300	_	_	V	$I_{c} = 3 \text{ A}, R_{BE} = \infty, L = 10 \text{ mH}$
Emitter to base breakdown voltage	$V_{\text{(BR)EBO}}$	7	_	_	V	$I_{\rm E}$ = 50 mA, $I_{\rm C}$ = 0
Collector cutoff current	I _{CEO}	_	_	100	μΑ	$V_{CE} = 300 \text{ V}, R_{BE} = \infty$
DC current transfer ratio	h _{FE}	500	_	_		$V_{CE} = 2 \text{ V}, I_{C} = 4 \text{ A}$
Collector to emitter saturation voltage	$V_{\scriptscriptstyle{CE(sat)}}$	_	_	1.5	V	$I_{c} = 4 \text{ A}, I_{B} = 40 \text{ mA}$
Base to emitter saturation voltage	$V_{{\sf BE}({\sf sat})}$	_	_	2.0	V	I _C = 4 A, I _B = 40 mA
Emitter to collector forward voltage	V _{ECF}	_	_	3.5	V	I _F = 6 A
Turn on time	t _{on}	_	1.2	_	μs	$I_{c} = 4 \text{ A}, V_{cc} = 20 \text{ V}$ $I_{B1} = -I_{B2} = 40 \text{ mA}$
Storage time	t _{stg}	_	8.0	_		
Fall time	t,	_	8.0	_		

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